

DATA SHEET 658, REV. -

**Standard Industrial Grade MOSFET Power Modules**

**FEATURES:**

- High Power Density
- Low Drain to Source Resistance ( $R_{DS(on)}$ )
- Low Thermal Resistance ( $R_{\theta JC}$ )

**INDUSTRIAL MOSFET PRODUCT MAP**

		$I_D$ (Amps)						
CONFIGURATION	$V_{DSS}$ (V)	10	25	50	100	200	300	400
Single	60	-	-	-	-	-	-	SPM1M350-006 SPM1M400-006
	100	-	-	-	-	SPM1M250-010	SPM1M300-010	-
	300	-	-	-	SPM1M130-030 SPM1M160-030	-	-	-
	600	-	-	SPM1M070-060	SPM1M090-060	-	-	-
	1000	-	-	SPM1M045-100 SPM1M065-100	-	-	-	-
Half-Bridge	60	-	-	-	-	SPM2M200-006 SPM2M250-006	-	-
	100	-	-	-	SPM2M150-010	SPM2M200-010	-	-
	300	-	-	-	SPM2M080-030 SPM2M120-030	-	-	-
	600	-	-	SPM2M040-060 SPM2M050-060	-	-	-	-
	1000	-	SPM2M025-100 SPM2M035-100	-	-	-	-	-
H-Bridge	60	-	-	SPC4M075-006	SPM4M130-006	-	-	-
	100	-	-	SPC4M045-010 SPC4M075-010	SPM4M130-010	-	-	-
	200	-	SPC4M030-020	SPC4M050-020	-	-	-	-
	300	-	-	SPC4M040-030	SPM4M080-030	-	-	-
	600	-	SPC4M020-060	SPM4M040-060	-	-	-	-
	1000	SPC4M012-100	SPM4M024-100	-	-	-	-	-

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**Industrial Grade MOSFET Power Modules**

<b>INDUSTRIAL MOSFET PRODUCT MAP</b>								
		<b>I<sub>D</sub> (Amps)</b>						
<b>CONFIG- URATION</b>	<b>V<sub>DSS</sub> (V)</b>	10	25	50	100	200	300	400
<b>Dual H-Bridge</b>	60	-	-	SPC8M075-006	-	-	-	-
	100	-	-	SPC8M045-010	-	-	-	-
	200	-	SPC8M030-020	-	-	-	-	-
	600	SPC8M011-060	-	-	-	-	-	-
<b>3-Phase Bridge</b>	60	-	-	SPC6M075-006	-	-	-	-
	100	-	-	SPC6M045-010	-	-	-	-
	200	-	SPC6M030-020	-	-	-	-	-
	600	SPC6M011-060	-	-	-	-	-	-
	1000	SPC6M006-100	-	-	-	-	-	-

**Note:**

Operating temperature range is -40°C to 125°C; storage temperature range is -40°C to 150°C.

**INDUSTRIAL MOSFET MODULES****Single Devices****MOSFET CHARACTERISTICS**

PART NUMBER	V <sub>DSS</sub>	Continuous Drain Current I <sub>c</sub> @ T <sub>c</sub> =25°C	Pulsed Drain Current T <sub>c</sub> =25°C	R <sub>ds(on)</sub> @I <sub>D</sub>		C <sub>iss</sub> Typ	t <sub>rr</sub> max 25°C	Maximum P <sub>D</sub> @ T <sub>c</sub> =25°C	R <sub>θJC</sub>
	Volts			Amps	Amps				
SPM1M350-006	60	350	900	0.003	60	18	60	800	0.14
SPM1M400-006	60	400	1000	0.002	100	28	60	1000	0.11
SPM1M250-010	100	250	700	0.007	60	18	200	1000	0.11
SPM1M300-010	100	300	900	0.005	100	28	200	1500	0.07
SPM1M130-030	300	130	400	0.030	60	18	200	1000	0.11
SPM1M160-030	300	160	600	0.018	90	28	200	1500	0.07
SPM1M070-060	600	70	250	0.100	30	18	250	1000	0.11
SPM1M090-060	600	90	350	0.070	50	28	250	1500	0.07
SPM1M045-100	1000	45	140	0.300	20	18	250	1000	0.11
SPM1M065-100	1000	65	200	0.200	25	28	250	1500	0.07

**Half-Bridge Devices****MOSFET CHARACTERISTICS**

PART NUMBER	V <sub>DSS</sub>	Continuous Drain Current I <sub>c</sub> @ T <sub>c</sub> =25°C	Pulsed Drain Current T <sub>c</sub> =25°C	R <sub>ds(on)</sub> @I <sub>D</sub>		C <sub>iss</sub> Typ	t <sub>rr</sub> max 25°C	Maximum P <sub>D</sub> @ T <sub>c</sub> =25°C	R <sub>θJC</sub>
	Volts			Amps	Amps				
SPM2M200-006	60	200	500	0.005	40	9.0	60	460	0.27
SPM2M250-006	60	250	600	0.004	60	14	60	600	0.20
SPM2M150-010	100	150	400	0.013	40	9.0	200	600	0.20
SPM2M200-010	100	200	500	0.009	60	14	200	900	0.13
SPM2M080-030	300	80	250	0.055	40	9.0	200	600	0.20
SPM2M120-030	300	120	350	0.035	60	14	200	900	0.13
SPM2M040-060	600	40	150	0.180	20	9.0	250	600	0.20
SPM2M050-060	600	50	200	0.120	30	14	250	900	0.13
SPM2M025-100	1000	25	75	0.55	10	9.0	250	600	0.20
SPM2M035-100	1000	35	120	0.37	15	14	250	900	0.13

**H-Bridge Devices****MOSFET CHARACTERISTICS**

PART NUMBER	V <sub>DSS</sub>	Continuous Drain Current I <sub>c</sub> @ T <sub>c</sub> =25°C	Pulsed Drain Current T <sub>c</sub> =25°C	R <sub>ds(on)</sub> @I <sub>D</sub>		C <sub>iss</sub> Typ	t <sub>rr</sub> max 25°C	Maximum P <sub>D</sub> @ T <sub>c</sub> =25°C	R <sub>θJC</sub>
	Volts			Amps	Amps				
SPM4M130-006	60	130	400	0.006	20	6.0	60	230	0.56
SPM4M130-010	100	130	400	0.011	20	9.0	200	600	0.20
SPM4M080-030	300	80	300	0.053	20	9.0	200	600	0.20
SPM4M040-060	600	40	120	0.180	20	9.0	250	900	0.20
SPM4M024-100	1000	24	70	0.55	15	9.0	250	600	0.20
SPC4M075-006	60	75	220	0.010	20	2.8	60	150	1.0
SPC4M045-010	100	45	130	0.030	20	3.5	170	180	0.70
SPC4M075-010	100	75	300	0.020	20	4.5	200	300	0.40
SPC4M030-020	200	30	120	0.075	15	2.8	360	180	0.70
SPC4M050-020	200	50	200	0.05	15	4.5	200	300	0.40
SPC4M040-030	300	40	150	0.085	20	4.8	200	300	0.40
SPC4M020-060	600	20	80	0.350	10	4.5	250	300	0.40
SPC4M012-100	1000	12	45	1.00	6.0	4.0	250	300	0.40

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**Dual H-Bridge Devices****MOSFET CHARACTERISTICS**

PART NUMBER	V <sub>DSS</sub>	Continuous Drain Current I <sub>c</sub> @ T <sub>c</sub> =25°C	Pulsed Drain Current T <sub>c</sub> =25°C	R <sub>ds(on)</sub> @I <sub>D</sub>		C <sub>iss</sub> Typ	t <sub>rr</sub> max 25°C	Maximum P <sub>D</sub> @ T <sub>C</sub> =25°C	R <sub>θJC</sub>
	Volts			Amps	Amps				
SPC8M075-006	60	75	220	0.010	20	2.8	60	150	1.0
SPC8M045-010	100	45	130	0.030	20	3.5	170	180	0.70
SPC8M030-020	200	30	120	0.075	15	2.8	360	180	0.70
SPC8M011-060	600	11	45	0.55	5.0	2.7	250	180	0.40

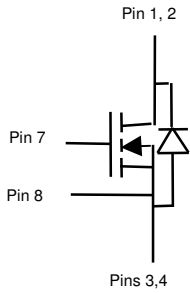
**DIODE CHARACTERISTICS**

PART NUMBER	Current Rating I <sub>FavM</sub> @ D=0.5, T <sub>c</sub>		V <sub>F</sub> @ I <sub>F</sub> T <sub>J</sub> =25°C Typ		t <sub>rr</sub> @ -di/dt=100A/μsec, T <sub>J</sub> =25°C	Thermal Resistance R <sub>θJC</sub>
	Amps	°C	Volts	Amps	Typ	°C/W
SPC8M075-006	25	80	1.05	25	30	1.6
SPC8M045-010	25	80	1.05	25	30	1.6
SPC8M030-020	25	80	1.05	25	30	1.6
SPC8M011-060	15	80	1.6	15	50	1.6

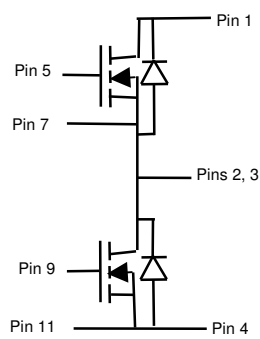
**Three-Phase Bridge Devices****MOSFET CHARACTERISTICS**

PART NUMBER	V <sub>DSS</sub>	Continuous Drain Current I <sub>c</sub> @ T <sub>c</sub> =25°C	Pulsed Drain Current T <sub>c</sub> =25°C	R <sub>ds(on)</sub> @I <sub>D</sub>		C <sub>iss</sub> Typ	t <sub>rr</sub> max 25°C	Maximum P <sub>D</sub> @ T <sub>C</sub> =25°C	R <sub>θJC</sub>
	Volts			Amps	Amps				
SPC6M075-006	60	75	220	0.010	20	2.8	60	150	1.0
SPC6M045-010	100	45	130	0.030	20	3.5	170	180	0.70
SPC6M030-020	200	30	120	0.075	15	2.8	360	180	0.70
SPC6M011-060	600	11	45	0.55	5.0	2.7	250	180	0.70
SPC6M006-060	1000	6.0	24	2.0	3.0	2.6	250	180	0.70

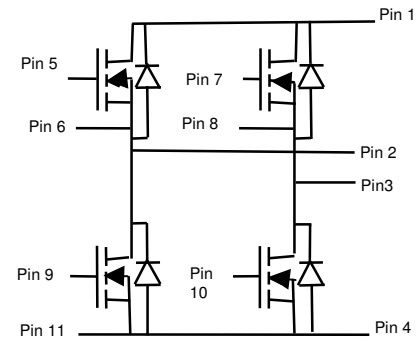
**SCHEMATIC DIAGRAMS**  
(for SPMxMxxx-xxx)



Schematic for  
SPM1Mxxx-xxx



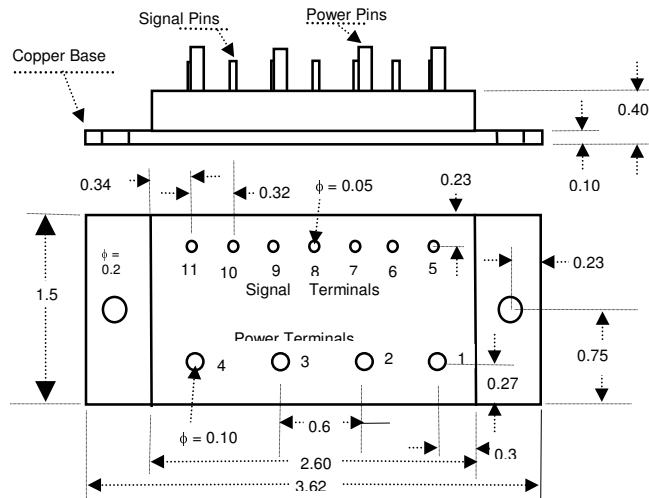
Schematic for  
SPM2Mxxx-xxx



Schematic for  
SPM4Mxxx-xxx

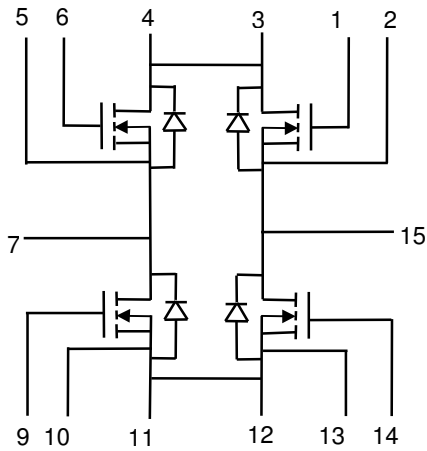
**PACKAGE OUTLINE**

(for SPM1Mxxx-xxx, SPM2Mxxx-xxx, SPM4Mxxx-xxx)  
(All dimensions are in inches)

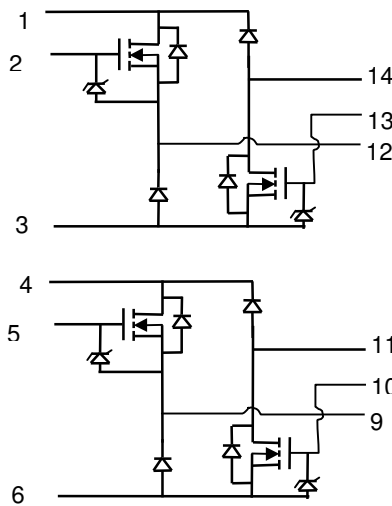


**SCHEMATIC DIAGRAM**

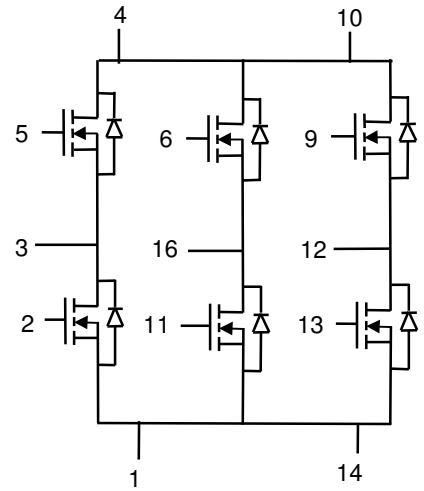
(for SPCXMxxx-xxx)



Schematic for  
SPC4Mxxx-xxx



Schematic for  
SPC8Mxxx-xxx

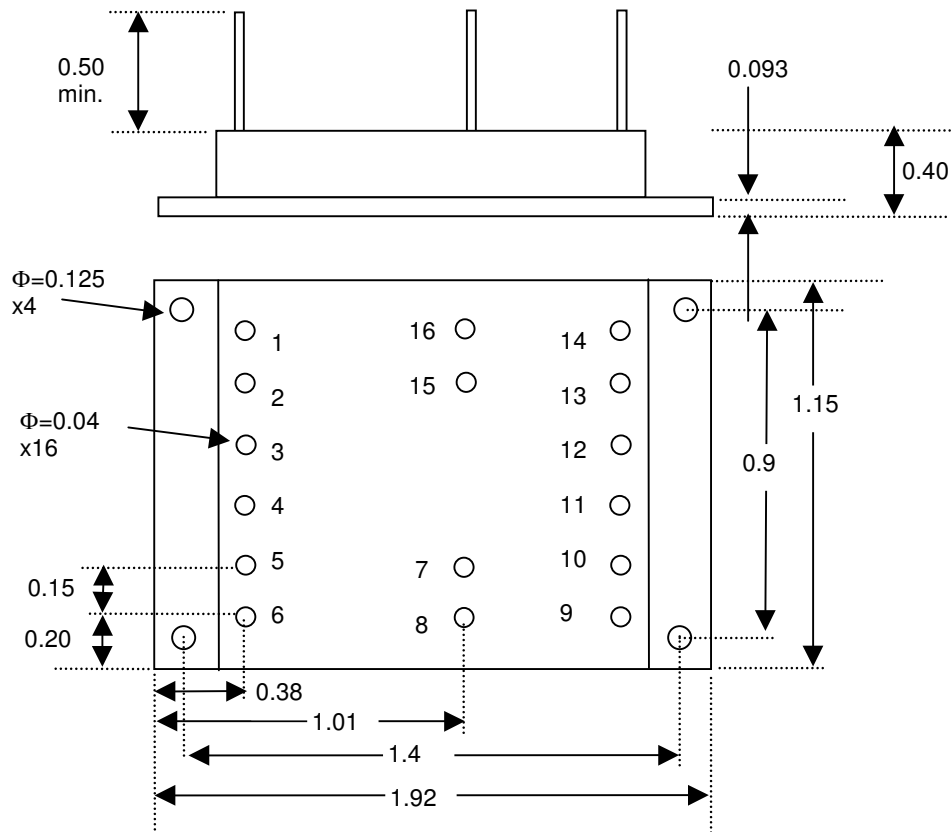


Schematic for  
SPC6Mxxx-xxx

**PACKAGE OUTLINE**

(for SPC4Mxxx-xxx, SPC8Mxxx-xxx, SPC6Mxxx-xxx)

(All dimensions are in inches)



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